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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

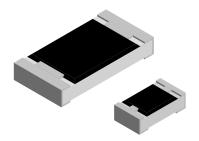






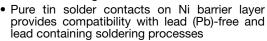


Pulse Proof, High Power Thick Film Chip Resistors



FEATURES

- Excellent pulse load capability
- Enhanced power rating
- · Double side printed resistor element
- Protective overglaze





- · AEC-Q200 qualified, rev. C compliant
- · Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

STANDARD ELECTRICAL SPECIFICATIONS											
MODEL	CASE SIZE INCH	CASE SIZE METRIC	POWER RATING P ₇₀ W	LIMITING ELEMENT VOLTAGE U _{max.} AC/DC	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES			
			0.125 ⁽¹⁾	50	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW0402-HP e3	0402	RR1005			± 200	± 5		E24			
			Zero-Ohm-Resisto	r: R_{max} . = 0.010	Ω , $I_{\text{max.}} = 3 \text{ A}$						
		RR1608	0.25	75	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW0603-HP e3	0603				± 200	± 5	1 10 1141	E24			
			Zero-Ohm-Resisto	r: R_{max} . = 0.008	Ω , $I_{\text{max.}} = 5 \text{ A}$						
	0805	RR2012	0.33	150	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW0805-HP e3					± 200	± 5	1 to 11vi	E24			
			Zero-Ohm-Resisto	r: R_{max} . = 0.005	Ω , $I_{\text{max.}} = 6 \text{ A}$						
	1206	RR3216	0.5	200	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW1206-HP e3					± 200	± 5		E24			
			Zero-Ohm-Resistor: $R_{\text{max.}} = 0.005 \Omega$, $I_{\text{max.}} = 10 \text{ A}$								
	1210	RR3225	0.75	200	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW1210-HP e3					± 200	± 5		E24			
			Zero-Ohm-Resistor: R_{max} . = 0.004 Ω , I_{max} . = 12 A								
	1218	RR3246		200	± 100	± 0.5, ± 1	1 to 1M	E24; E96			
CRCW1218-HP e3			1.5		± 200	± 5	I LO TIVI	E24			
			Zero-Ohm-Resisto	r: R_{max} . = 0.004	Ω , $I_{\text{max.}} = 20 \text{ A}$						
	2010	RR5025	1.0		± 100	± 0.5, ± 1	4 1 4 4 4	E24; E96			
CRCW2010-HP e3				400	± 200	± 5	1 to 1M	E24			
			Zero-Ohm-Resisto	r: R _{max} . = 0.005	Ω , $I_{\text{max.}} = 12 \text{ A}$						
	2512	RR6332	1.5	500	± 100	± 0.5, ± 1	4 1 4 4 4	E24; E96			
CRCW2512-HP e3					± 200	± 5	1 to 1M	E24			
			Zero-Ohm-Resistor: $R_{\text{max.}} = 0.005 \Omega$, $I_{\text{max.}} = 16 \text{ A}$								

Notes

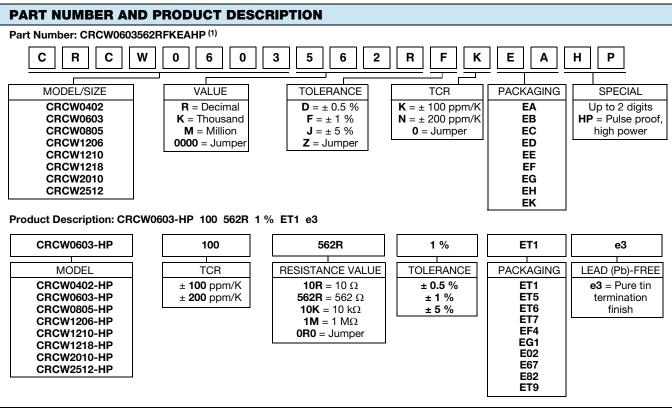
- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

 Marking: See document "Surface Mount Resistor Marking" (document number 20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
- CRCW0402-HP resistors feature a single side printed resistive layer only.

TECHNICAL SPECIFICATIONS									
PARAMETER	UNIT	CRCW 0402-HP	CRCW 0603-HP	CRCW 0805-HP	CRCW 1206-HP	CRCW 1210-HP	CRCW 1218-HP	CRCW 2010-HP	CRCW 2512-HP
Rated dissipation P ₇₀ ⁽²⁾	W	0.125	0.25	0.33	0.5	0.75	1.5	1.0	1.5
Limiting element voltage U _{max.} AC/DC		50	75	150	200	200	200	400	500
Insulation voltage U _{ins.} (1 min)		> 75	> 100	> 200	> 300	> 300	> 300	> 300	> 300
Insulation resistance Ω > 10 ⁹									
Category temperature range	°C	- 55 to + 155							
Weight	mg	0.65	2	5.5	10	18	31	25.5	42

Note

The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

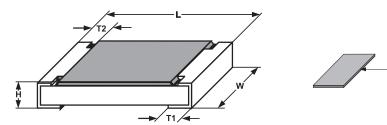


Note

⁽¹⁾ Preferred way for ordering products is by use of the PART NUMBER.

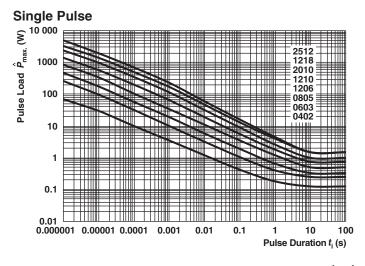
PACKAGING									
MODEL	UNIT	AC	PAPER TAPE ON CC. TO IEC 60286-		BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II				
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.		
CRCW0402-HP	180 mm/7" 330 mm/13"	10 000 50 000	ED EE	ET7 EF4					
CRCW0603-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW0805-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1206-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1210-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1218-HP	180 mm/7"				4000	EK	ET9		
CRCW2010-HP	180 mm/7"				4000	EF	E02		
CRCW2512-HP	180 mm/7"				2000 4000	EG EH	E67 E82		

DIMENSIONS in millimeters



SIZE DIMENSIONS						SOLDER PAD DIMENSIONS							
3	DIZE		DIMENSIONS					W SOLD	ERING	WAVE SOLDERING			
INCH	METRIC	L	w	Н	T1	T2	а	b	I	а	b	I	
0402	1005	1.0 ± 0.05	0.5 ± 0.05	0.3 ± 0.1	0.25 ± 0.1	0.2 ± 0.1	0.4	0.6	0.5				
0603	1608	1.6 ± 0.1	0.85 ± 0.1	0.45 ± 0.1	0.3 ± 0.2	0.3 ± 0.2	0.5	0.9	1.0	0.9	0.9	1.0	
0805	2012	2.0 ± 0.15	1.25 ± 0.15	0.50 ± 0.1	0.4 ± 0.2	0.35 ± 0.2	0.7	1.3	1.2	0.9	1.3	1.3	
1206	3216	3.1 ± 0.2	1.6 ± 0.15	0.50 ± 0.15	0.5 ± 0.2	0.45 ± 0.2	0.9	1.7	2.0	1.1	1.7	2.3	
1210	3225	3.2 ± 0.2	2.5 ± 0.2	0.6 ± 0.1	0.45 ± 0.2	0.4 ± 0.2	0.9	2.5	2.0	1.1	2.5	2.2	
1218	3246	3.1 ± 0.2	4.6 ± 0.2	0.6 ± 0.1	0.45 ± 0.2	0.4 ± 0.2	1.05	4.9	1.9	1.25	4.8	1.9	
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	2.5	3.9	1.2	2.5	3.9	
2512	6332	6.3 ± 0.2	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	3.2	5.2	1.2	3.2	5.2	

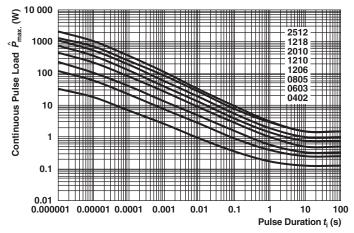
FUNCTIONAL PERFORMANCE



Maximum pulse load, single pulse; applicable if $\bar{P} \to 0$ and n < 1000 and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

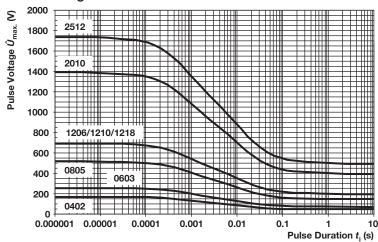






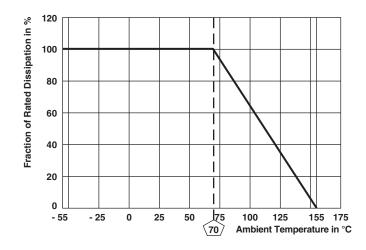
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P \; (\vartheta_{amb})$ and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max.}$; for permissible resistance change equivalent to 8000 h operation

DERATING





TEST	PROCED	OURES AND REQUIREMEN	TS			
EN 60068-2		TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)		
CLAUSE	TEST METHOD			STABILITY CLASS 2 OR BETTER		
			Stability for product types:	401.4140		
			CRCW-HP e3	1 Ω to 1 MΩ		
4.5	-	Resistance	-	± 0.5 %, ± 1 %, ± 5 %		
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	-		
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max.}}$; duration: According to style	± (0.5 % R + 0.05 Ω)		
4 17 0	E0 /T4\	Coldovahilib	Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage		
4.17.2	58 (Td)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 ± 5) °C; (3 ± 0.3) s	Good tinning (≥ 95 % covered) no visible damage		
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K, ± 200 ppm/K		
4.32	21 (UU3)	Shear (adhesion)	RR 1608 and smaller: 9 N RR 2012 and larger: 45 N	No visible damage		
4.33	21 (UU1)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$		
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles	± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)		
4.23	-	Dry heat	-			
4.23.2	2 (Ba)	Damp heat, cyclic	125 °C; 16 h			
4.23.3	30 (Db)	cold	55 °C; ≥ 90 % RH; 24 h; 1 cycle			
4.23.4	1 (Aa)	Low air pressure	- 55 °C; 2 h	± (2 % R + 0.1 Ω)		
4.23.5	13 (M)	-	1 kPa; (25 ± 10) °C; 1 h			
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycle			
4.23.7	-	D.C. load	$U = \sqrt{P_{70} \times R}$			
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max}}.$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	± (2 % R + 0.1 Ω) ± (4 % R + 0.1 Ω)		
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.5 % R + 0.05 Ω)		
4.35	-	Flammability, needle flame test	IEC 60695-15-5; 10 s	No burning after 30 s		
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R + 0.05 Ω)		
4.25.3	-	Endurance at upper category temperature	155 °C; 1000 h	± (2 % R + 0.1 Ω)		
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 positive and 3 negative discharges; ESD voltage according to size	± (1 % R + 0.05 Ω)		
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage		
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1; toothbrush	Marking legible, no visible damage		
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10$ Hz to 2000 Hz; x, y, z \leq 1.5 mm; A \leq 200 m/s2; 10 sweeps per axis	$\pm (0.5 \% R + 0.05 \Omega)$		
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \le 2 \times U_{\text{max.}}$ 0.1 s "ON"; 2.5 s "OFF"; 1000 cycles	± (1 % R + 0.05 Ω)		
4.27	-	Single pulse high voltage overload, 10 μs/700 μs	$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}}$ 10 pulses	± (1 % R + 0.05 Ω)		
		-				

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.



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Vishay

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